		1. PCN Basic Data		
1.1 Company		Allegro MicroSystems microsystems 955 Perimeter Rd, Manchester, New Hampshire		
1.2 PCN No.		PbFreeCS		
1.3 Title of PCN		Lead (Pb) Free Conversion - Solder Bumps		
1.4 Customer		AVNET EUROPE		
1.5 Product Category		Active Components – Integrated Circuits		
1.6 Issue Date	5 Issue Date 19-Jul-2021			
1.7 PCN Revision Histor	y (optional)	1.8 Issue Date of Previous Revision (optional)	1.9 Delta to Previous Revisio	
NA				

	2. PCN Team		
2.1 Contact Supplier			
2.1.1 Name	Heather Brogna		
2.1.2 Phone	603-626-2300		
2.1.3 Email	Hbrogna@allegromicro.com		
2.2 Team Supplier (optional)			
2.2.1 Name (optional)	2.2.2 Phone (optional)	2.2.3 Email	

		3. Changes	
No.	3.0 Identification	3.1 Category	3.2 Туре с
#1	SEM-PA-06	PROCESS - ASSEMBLY	Bump Material / Metall Syste
#2	SEM-PA-14	PROCESS - ASSEMBLY	Change in process technology (e.g. sawing, die attach, bond and form, lead frame prepera
#3	SEM-PA-15	PROCESS - ASSEMBLY	Process integrity: tuning with
#4			
#5			
#6			
#7			

	1. PCN Basic Data	
1.1 Company	Allegro MicroSystems 955 Perimeter Rd, Manchester, New Hampshire	
1.2 PCN No.	PbFreeCS	
1.3 Title of PCN	Lead (Pb) Free Conversion - Solder Bumps	
#8		
#9		
#10		

	4. Description of Change		
	Current	Ne	
Change #1	Current parts utilize leaded (SnPb) solder bumps	New solder bumps wil be ma	
Change #2	Current parts do not include Epoxy Dotting	Epoxy dotting added to the a	
Change #3	Currently no Epoxy Dots	Adding Epoxy Dots to control improving the high voltage is	
Change #4			
Change #5			
Change #6			
Change #7			
Change #8			
Change #9			
Change #10			
4.6 Anticipated Impact on Form, Fit, Function, Reliability or Processability?	No anticipated impact to fit, form or function but da device performance.	tasheet specification limits are ir	
4.7 Reference Parts with Customer Number (optional)			

	5. Reason / Motivation for Change
5 1 MOTIVATION	The European Union (EU) has released Directive 2002/95/EC (RoHS) and requires parts with solder bumps to be lead (Pb) free (previously 7a exem
5.2 Additional Explanation (optional)	

6. M	arking of Parts / Traceability of Change
6.1 Description	Top brand moves from ACS723T to ACS723S to signify the SnAg version.

		1. PCN Basic Data	a
1.1 Company		s 955 P	Allegro MicroSystems Perimeter Rd, Manchester, New Hampshire 0310
1.2 PCN No.		PbFreeCS	
1.3 Title of PCN		Lead (Pb) Free Conversion	n - Solder Bumps
		7. Timing / Schedu	ıle
7.1 Date of Qualificat	tion Results		
7.2 Last Order Date (optional)		
7.3 Last Delivery Dat	e (optional)		
7.4 Intended Start of	Delivery	2021.11.01	
7 E Qualification Sam	mlac Availabla?	Yes	
7.5 Qualification Sam		Date Available	Now
7.6 Customer Feedba	ack Required Until		
		8. Qualification / Valid	dation
		Qual Data 0 100	

	· · · · ·		
8.1 Description	Qual Data, Q-100		
(e.g. qual. plan/report, AEC-Q)			
8.2 Qualification Report and Qualification Results		Issue Date	

9. Input to Customer for Risk Assessment Process

Under Allegro's procedure for product/process change notification, Allegro strives, based on its technical judgment, to provide notification of may affect form, fit, function, reliability/durability and processability/manufacturability. However, as Allegro cannot ensure evaluation of preach and every application; the customer retains responsibility to validate the impact of a change on its application suitability.

10. Attachments (e.g. new datasheet, additional documentation, pictures, process flow, sample plan, ...)

			1. PC	N Basic Data			
1.1 Company		GRO		955 Per	All imeter Rd, Mai	egro MicroSyst nchester, New	
1.2 PCN No.			PbFreeCS				
1.3 Title of PCN			Lead (Pb) Fre	e Conversion -	Solder Bumps		
				ffected Parts			
	11	.1 Current					11.2 New
	11.1.2 Supplier Catalog Part No.	11.1.3 Supplier Internal Part No. (optional)	11.1.4 Package Name	11.1.5 Part Description (optional)	11.1.6 Additional Part Information (optional)	11.2.2 Supplier Catalog Part No.	11.2.3 Supplier Internal Part No. (optional)
ACS723LLCTR-40AB-T	ACS723LLCTR-40AB-T	(optional)			(optional)		(optional)
ACS723LLCTR-20AU-T ACS723LLCTR-05AB-T ACS723LLCTR-10AU-T ACS723LLCTR-20AB-T ACS723LLCTR-10AB-T	ACS723LLCTR-20AU-T ACS723LLCTR-05AB-T ACS723LLCTR-10AU-T ACS723LLCTR-20AB-T ACS723LLCTR-10AB-T						
							Form a

Please note: It is our intention to inform our customer of changes as early as possible. Under Allegro's procedure for product/process change strives, based on its technical judgment, to provide notification of significant changes that may affect form, fit, function, reliability/durability processability/manufacturability. However, as Allegro cannot ensure evaluation of product/process changes for each and every application; responsibility to validate the impact of a change on its application suitability. If samples are needed for validation of a change, requests may information provided herein. Please contact your Account Manager or Local Sales Representative for any questions. We kindly request you meet our target date for implementation. Unless both parties agree to extend the implementation date, this change will be implemented as

)3 U.S.A.
•
on (optional)
(optional)
of Change
of Change
of Change Im (internal)
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em (internal)
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em (internal)
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em (internal) / ling, moulding, plating, trim
em (internal) / ling, moulding, plating, trim ation,)

)3 U.S.A. w de from silver (SnAg) ssembly process bump height specs and olation performance ncreasing to reflect actual 2011/65/EU (RoHS II) which າpt).

)3 U.S.A.
JS U.S.A.
of significant changes that
roduct/process changes for

)3 U.S.A.	
applicable)	
11.2.4	11.2.6
Package	Additional
Name	Part
	Information
	(optional)
oted from ZVEI Re	vision 3.0.0

e notification, Allegro and the customer retains be made via the contact consideration so we can scheduled.